

Entrusted Items Concerning Preparation of Draft Proposals for JIS

Newly Established

Divisional Council	T i t l e	Assigned Organization	Contact
Electronics	The marking for presence of the specific chemical substances for electric and electric and equipment	Japan Electronics & Information Technology Industries Association	C
Electronics	Fixed resistors for use in electronic equipment Part 9 : Sectional specification : Fixed surface mount resistor networks with individually	Japan Electronics & Information Technology Industries Association	C
Electronics	Fixed resistors for use in electronic equipment Part 9: Blank detail specification: Fixed surface mount resistor networks with individually measurable resistors Assessment level EZ	Japan Electronics & Information Technology Industries Association	C
Electronics	Fixed capacitors for use in electronic equipment – Part 21: Sectional specification: Fixed surface mount multilayer capacitors of ceramic	Japan Electronics & Information Technology Industries Association	C
Electronics	Fixed capacitors for use in electronic equipment – Part 21: Blank detail specification: Fixed surface mount multilayer capacitors of ceramic dielectric, Class 1 – Assessment level EZ	Japan Electronics & Information Technology Industries Association	C
Electronics	Fixed capacitors for use in electronic equipment – Part 22: Sectional specification: Fixed surface mount multilayer capacitors of ceramic	Japan Electronics & Information Technology Industries Association	C
Electronics	Fixed capacitors for use in electronic equipment – Part 22: Blank detail specification: Fixed surface mount multilayer capacitors of ceramic dielectric, Class 2 – Assessment level EZ	Japan Electronics & Information Technology Industries Association	C
Electronics	High frequency inductive components electrical characteristics and methods Part 1: Nanohenry range chip inductor	Japan Electronics & Information Technology Industries Association	C
Electronics	High frequency inductive components - Non-electrical characteristics and methods Part1:Fixed, surface mounted inductor for use in electronic and measuring telecommunication equipment	Japan Electronics & Information Technology Industries Association	C
Electronics	Printed board assemblies – Part 1:Generic specification – Requirements for soldered electrical and electric assemblies using surface mount and related assembly technologies	Japan Electronics & Information Technology Industries Association	C
Electronics	Printed board assemblies – Part 2:Sectional specification – Requirements for surface mount soldered assemblies	Japan Electronics & Information Technology Industries Association	C

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Electronics	Printed board assemblies – Part 3:Sectional specification – Requirements for through-hole mount soldered assemblies	Japan Electronics & Information Technology Industries Association	C
Electronics	Printed board assemblies – Part 4:Sectional specification – Requirements for terminal soldered assemblies	Japan Electronics & Information Technology Industries Association	C
Electronics	Packaging of components for automatic handling - Part 6: Bulk case packaging for surface mounting components	Japan Electronics & Information Technology Industries Association	C
Electronics	The marking for presence of the specific chemical substances for electric and electric and equipment	Japan Electronics & Information Technology Industries Association	C
Information technology	Information technology -- Automatic identification and data capture techniques -- Bar code symbology specifications -- PDF417	Japanese Standards Association Japan Automatic Identification Systems Association	C
Information technology	Identification cards -- Integrated circuit cards -- Part 15: Cryptographic information application	Japanese Standards Association Japan Business Machine and Information System Industries Association	C
Information technology	Identification cards -- Integrated circuit cards -- Part 5: Registration of application providers	Japanese Standards Association Japan Ic Card System APplication council	C
Information technology	Identification cards -- Integrated circuit cards -- Part 6: Interindustry data elements for interchange	Japanese Standards Association Japan Ic Card System APplication council	C
Information technology	Identification cards -- Integrated circuit cards -- Part 8: Commands for security operations	Japanese Standards Association Japan Ic Card System APplication council	C
Information technology	Identification cards -- Integrated circuit cards -- Part 9: Commands for card management	Japanese Standards Association Japan Ic Card System APplication council	C
Management	Quarity management systems - Guidelines for sustainable growth	Japanese Standards Association	D
Management	Quarity management systems - Guidelines for self-assessment	Japanese Standards Association	D
Management system	Environmental management - Environmental communication - Guidelines and examples	Japanese Standards Association	D
Management	Information security management - concepts and models	Japanese Standards Association	D
Management	Information security management - codes of conduct	Japanese Standards Association	D